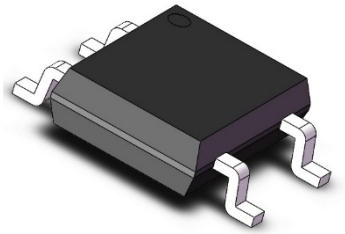
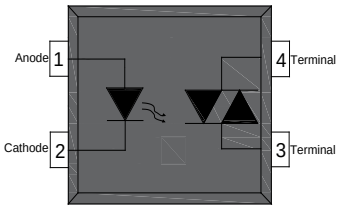
JOC302XM4 Series

Rev.A.1.0

DESCRIPTION:

The JOC302XM4 series combine an AIGaAs infrared emitting diode as the emitter which is optically coupled to a monolithic silicon random-phase photo triac in a plastic SOP4 package. With the robust coplanar double mold structure, JOC302XM4 series provide the most stable isolation feature. The products are widely used in solenoid/value controls, lighting controls, motor controls, temperature controls, static AC power switches, solid state relays, interfacing microprocessors up to 120 V_{AC} peripherals.





MAIN FEATURES

High isolation 3750 VRMS
DC input with random-phase photo triac output
Operating temperature range -55 ℃ to 100 ℃
REACH & RoHS compliance
Halogen free
MSL class 1
HBM: H3A ; MM: M4
CQC approved
VDE approved
UL approved

ABSOLUTE MAXIMUM RATINGS (Temperature=25°C)

Parameter		Symbol	Value	Unit
Input	Forward Current	I_F	60	mA
	Reverse Voltage	V_R	6	V
	Junction Temperature	T_j	125	℃
	Input Power Dissipation	P_I	100	mW
	Power Dissipation Derating (Ta≥25℃)	ΔP_D/℃	-1.33	mW/℃
Output	Off-state Output Terminal Voltage	V_{OFF}	400	V
	Peak On-state Current (100μs pulse, 120 pps)	I_{TP}	2	A
	On-state RMS Current	$I_{T(RMS)}$	100	mA
	Peak Repetitive Surge Current (P_W=10 ms)	I_{TSM}	1	A

	Junction Temperature	T_j	125	℃
	Output Power Dissipation	P_O	250	mW
	Power Dissipation Derating (Ta≥25℃)	ΔP_D/℃	-3.33	mW/℃
Total Power Dissipation		P_{tot}	350	mW
Isolation Voltage		V_{iso}	3750①	Vrms
Operating Temperature		T_{opr}	-55~100	℃
Storage Temperature		T_{stg}	-55~125	℃
Soldering Temperature		T_{sol}	260②	℃

NOTE1: AC for 1minute, R.H.=40~60%

NOTE2: For 10 seconds

ELECTRICAL CHARACTERISTICS (Temperature=25°C)

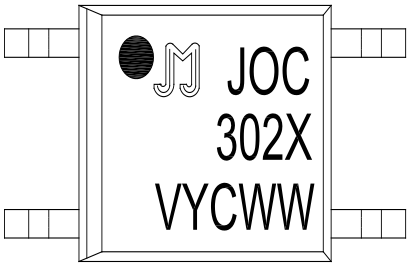
Parameter			Symbol	Condition	Min.	Typ.	Max.	Unit
Input	Forward Voltage		V_F	I_F=10mA	-	1.2	1.4	V
	Reverse Current		I_R	V_R=6V	-	-	1	μA
	Input Capacitance		C_{in}	V=0, f=1kHz	-	14	-	pF
Output	Peak Off-state Current, Either Direction		I_{OFF}	V_{OFF}=400V, I_F=0	-	-	100③	nA
	Peak On-state Voltage, Either Direction		V_{TM}	I_{TM}=100mA	-	2	2.5	V
	Critical Rate of Rise of Off-state voltage		dV/dt	V_{PEAK}=400V, I_F=0	1000④	-	-	V/μs
Transfer Characteristics	LED Trigger Current	JOC3021M4	I_{FT}	Terminal Voltage=3V I_{TM}=100mA	-	-	15	mA
		JOC3022M4			-	-	10	
		JOC3023M4			-	-	5	
	Holding Current		I_H	I_{TM}=2mA, I_F=Rated I_{FT}	-	250	-	μA
	Isolation Resistance		R_{ISO}	DC500V 40~60%R.H.	10^{12}	10^{14}	-	Ω
	Floating Capacitance		C_{IO}	V=0, f=1MHz	-	0.4	-	pF
	Response Time		t_{on}	V_D=6V, R_L=100Ω, I_F=20mA	-	15	50	μs

NOTE3: Test voltage must be applied within dV/dt ratings.

NOTE4: Refer to Fig.14 & Fig.15

ORDERING AND MARKING INFORMATION

MARKING INFORMATION



JOC : Company Abbr.
302X : Part Number & Rank
V : VDE Option
Y : Fiscal Year
C : Manufacturing Code
WW : Work Week

ORDERING INFORMATION

JOC302XMX(Z)-GV

JOC – Company Abbr.
302X – Rank
(1/2/3)
MX– SOP Package
Z – Tape and Reel Option (T1)
G – Green
V – VDE Option (V or None)

Packing Quantity

Option	Quantity	Quantity – Inner box	Quantity –Outer box
T1	3000 Units/Reel	4 Reels/Inner box	5 Inner box/Outer box =60k Units

Characteristics Curves

FIG.1: Forward Current vs. Ambient Temperature

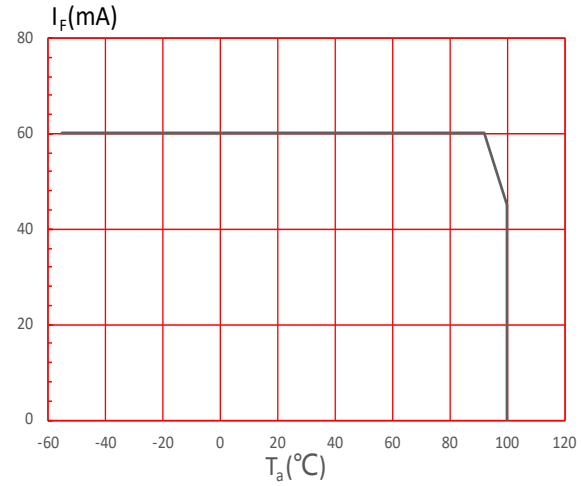


FIG.2: On-state Terminal Current vs. Ambient Temperature

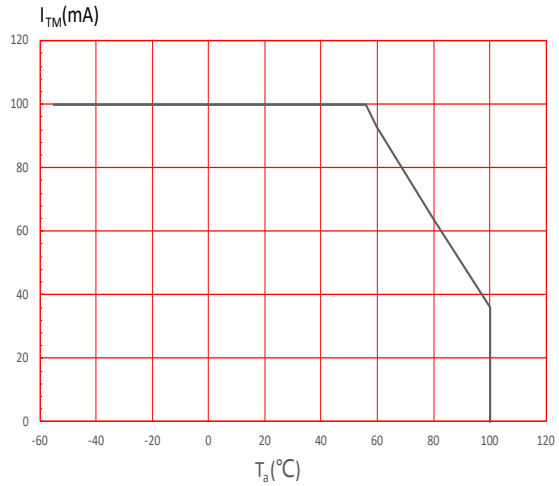


FIG.3: Forward Current vs. Forward Voltage

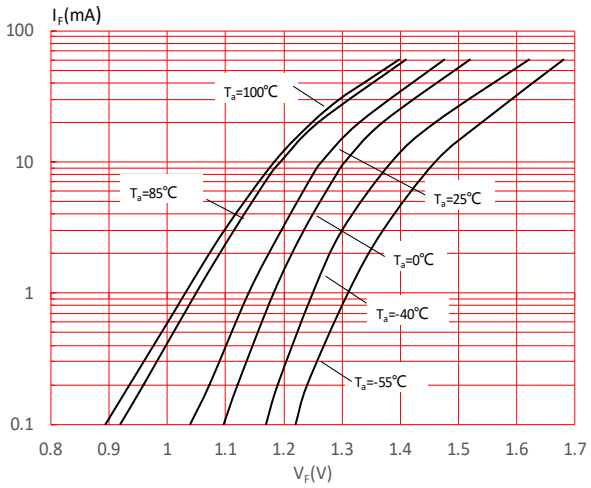


FIG.4: Normalized Off-state Terminal Current vs. Ambient Temperature

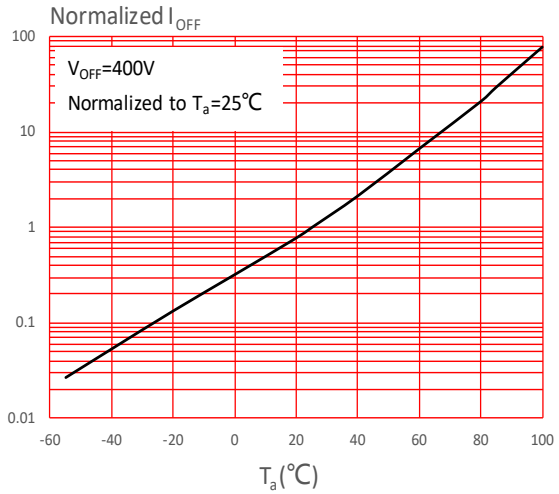


FIG.5: Normalized Off-state Terminal Voltage vs. Ambient Temperature

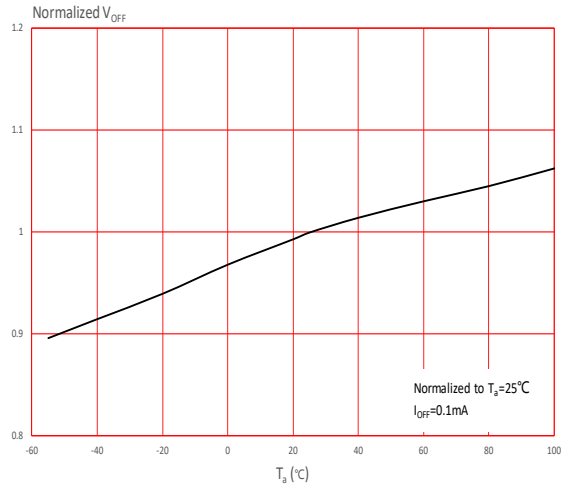


FIG.6: Normalized Trigger Current vs. Ambient Temperature

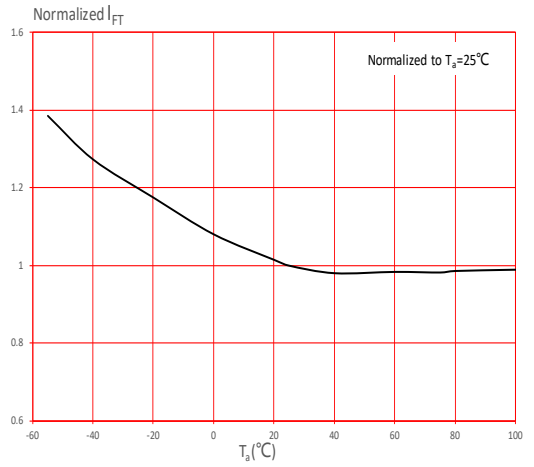


FIG.7: Normalized On-state Terminal Voltage vs. Ambient Temperature

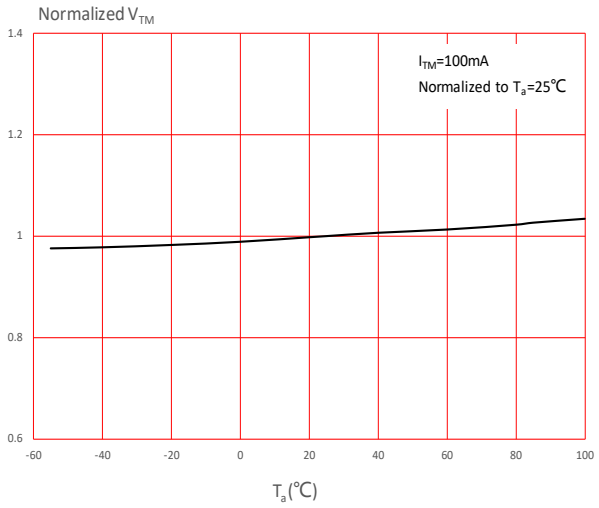


FIG.8: On-state Terminal Voltage vs. On-state Terminal Current

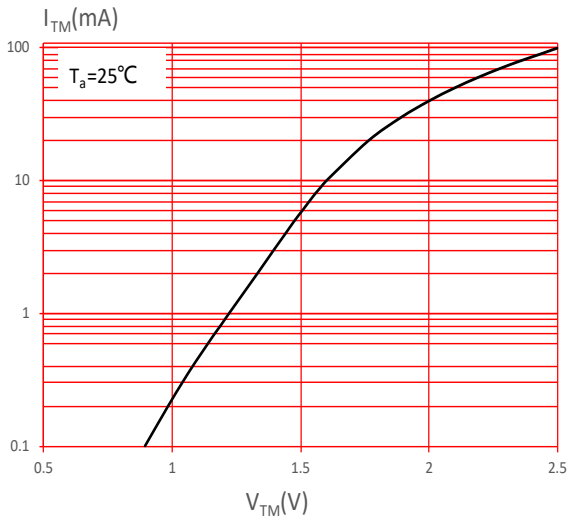


FIG.9: Normalized Holding Current vs. Ambient Temperature

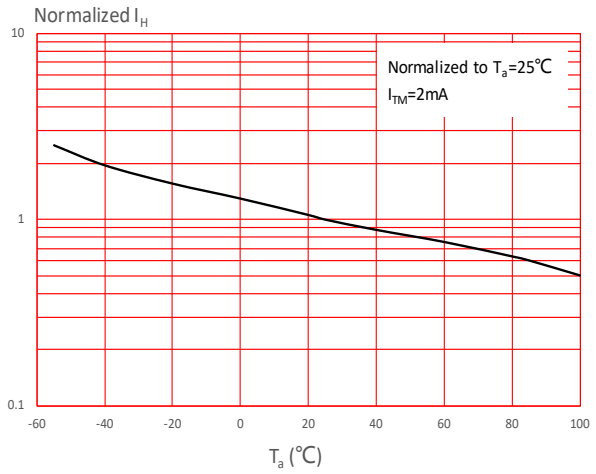


FIG.10: Turn On Time vs. Forward Current

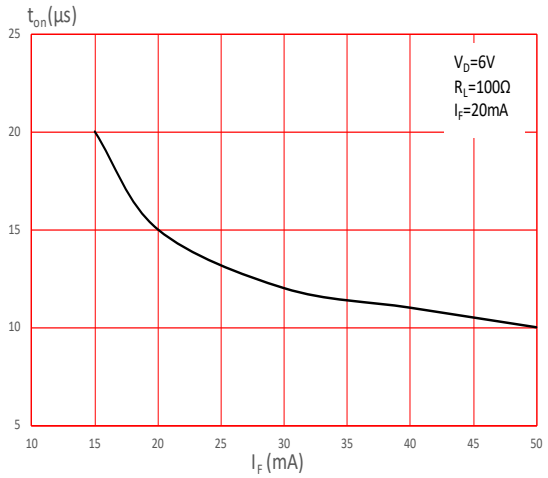
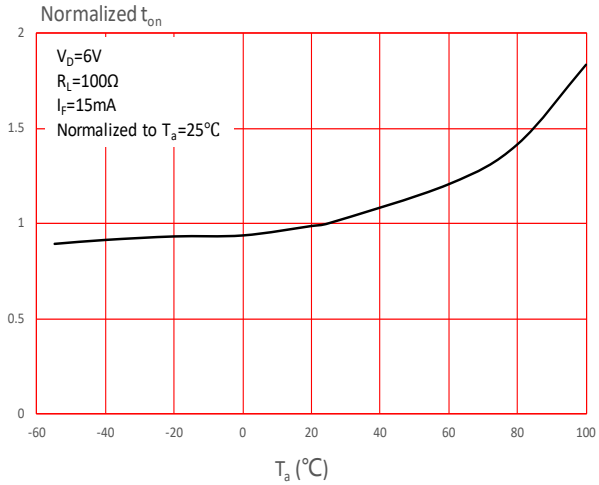


FIG.11: Normalized Turn On Time vs. Ambient Temperature



TEST CIRCUITS

FIG.12: Test Circuits of Turn On Time

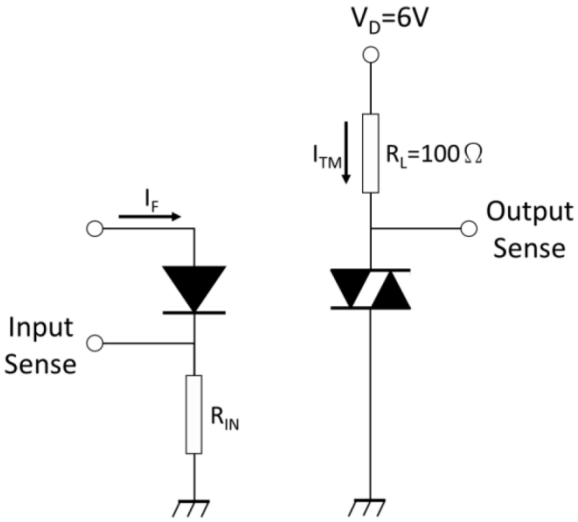


FIG.13: Waveforms of Turn On Time

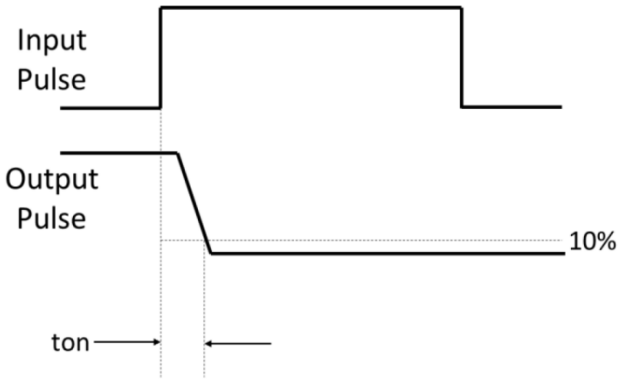


Fig.14: Test Circuits of dV/dt

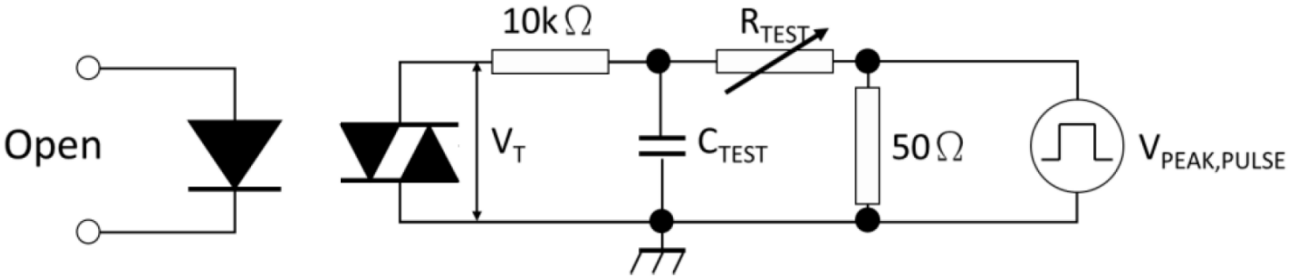
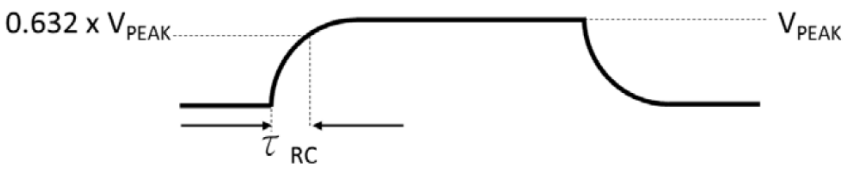
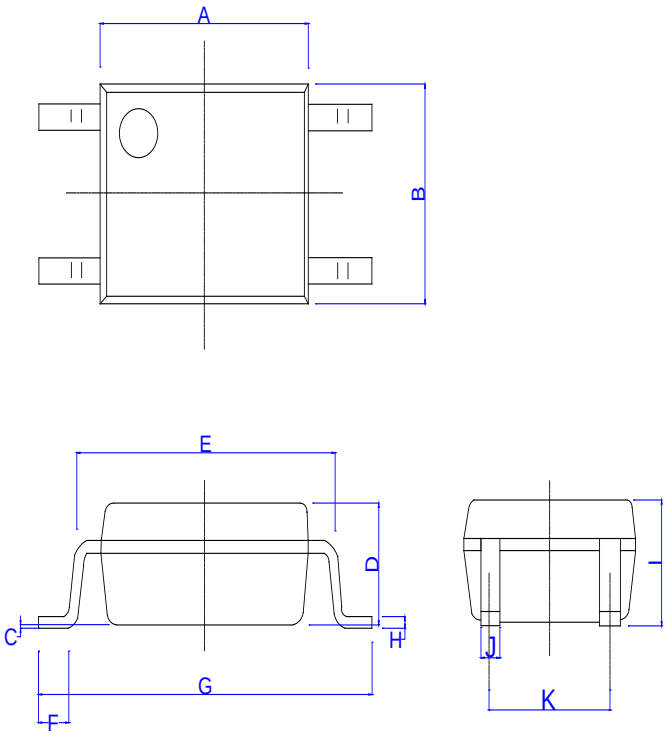


Fig.15: Waveforms of dV/dt



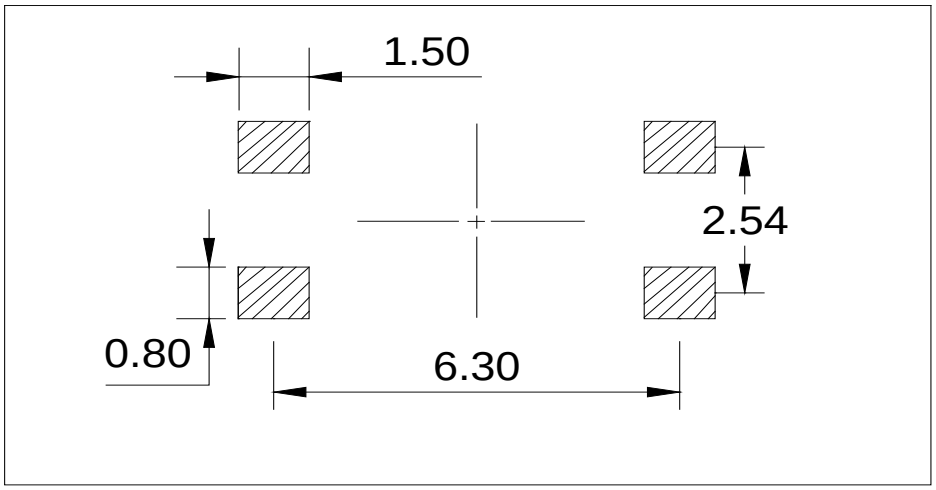
$$dv/dt = \frac{0.632 \times V_{PEAK}}{\tau_{RC}}$$

Package Dimension (Unit: mm）



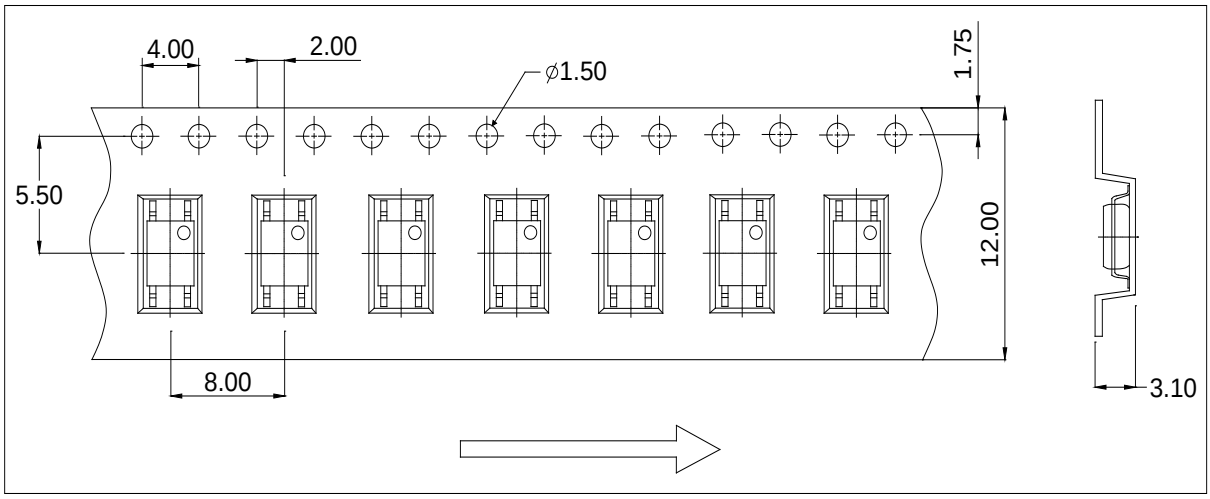
Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	4.20		4.60	0.166		0.182
B	3.30		3.90	0.130		0.154
C		0.10			0.004	
D	1.90		2.80	0.075		0.110
E	4.90		5.60	0.194		0.220
F		0.50			0.020	
G	6.30		7.30	0.248		0.289
H		0.20			0.008	
I		2.70			0.106	
J		0.40			0.016	
K		2.54			0.100	

RECOMMENDED SOLDER MASK (Dimensions in mm unless otherwise stated)



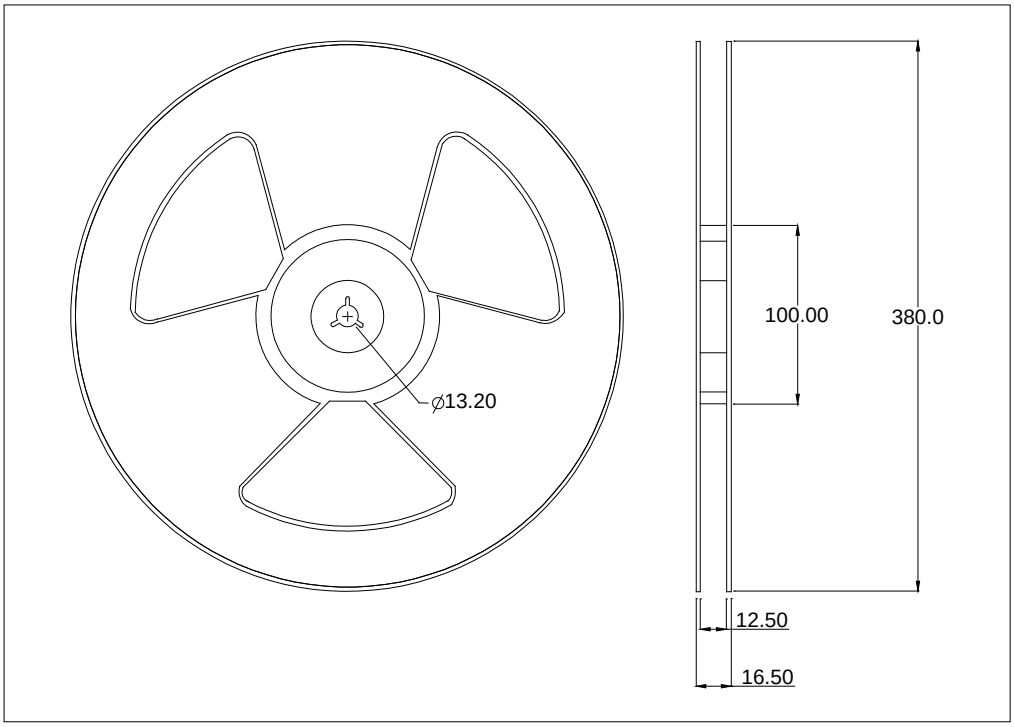
CARRIER TAPE SPECIFICATIONS (Dimensions in mm unless otherwise stated)

Option T1

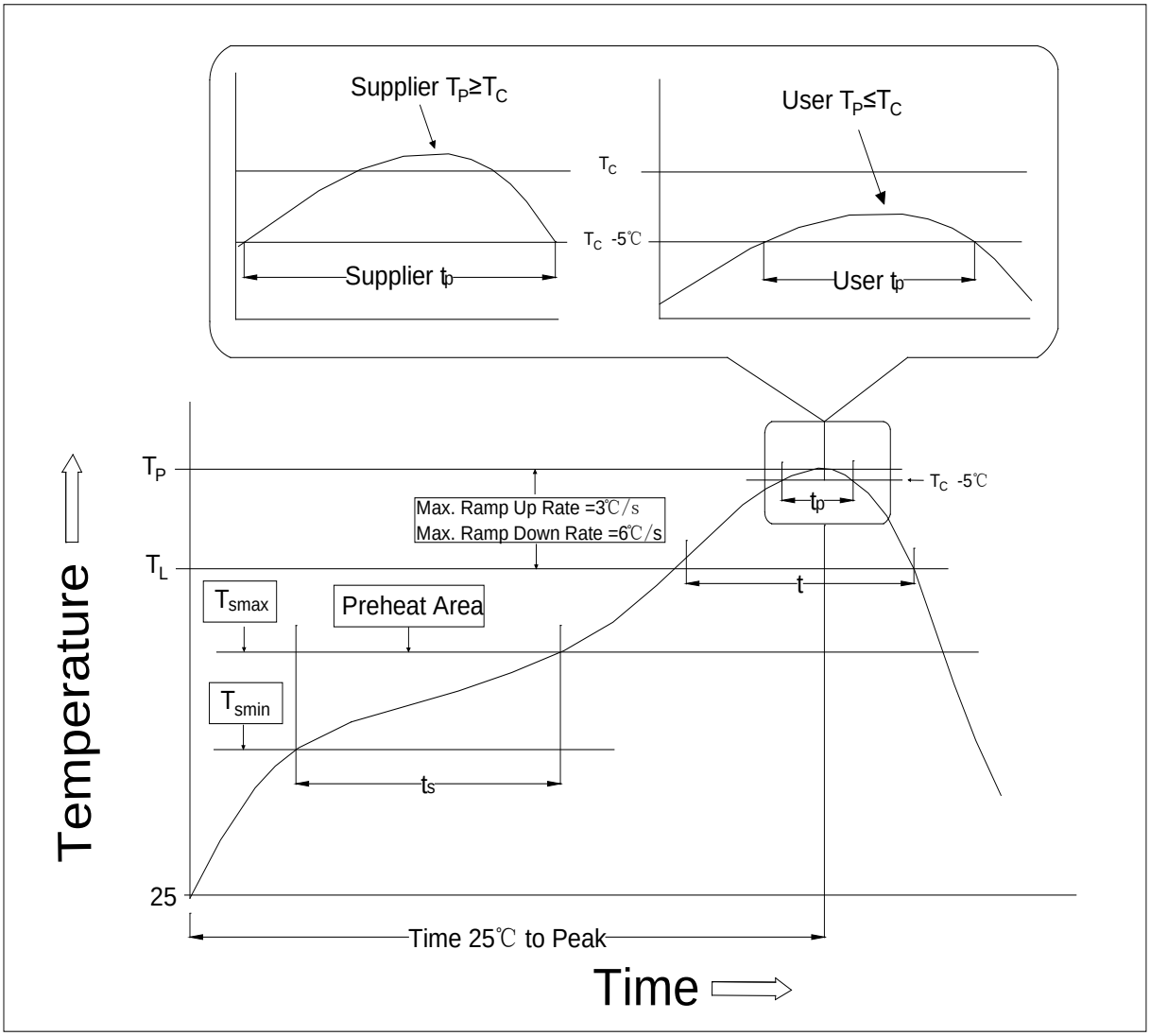


REEL SPECIFICATIONS (Dimensions in mm unless otherwise stated)

Option T1



REFLOW INFORMATION



Profile Feature	Sn-Pb Assembly Profile	Pb-Free Assembly Profile
Temperature Min. (Tsmin)	100	150℃
Temperature Max. (Tsmax)	150	200℃
Time (ts) from (Tsmin to Tsmax)	60-120 seconds	60-120 seconds
Ramp-up Rate (tL to tP)	3℃/second max.	3℃/second max.
Liquidus Temperature (TL)	183℃	217℃
Time (tL) Maintained Above (TL)	60-150 seconds	60-150 seconds
Peak Body Package Temperature	235℃+0℃/-5℃	260℃+0℃/-5℃
Time (tP) within 5℃ of 260℃	20 seconds	30 seconds
Ramp-down Rate (TP to TL)	6℃/second max.	6℃/second max.
Time 25℃ to Peak Temperature	6 minutes max.	8 minutes max.

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